



DMP3125L

#### 30V P-CHANNEL ENHANCEMENT MODE MOSFET

## **Product Summary**

BV <sub>DSS</sub>	RDS(ON) max	I <sub>D</sub> T <sub>A</sub> = +25°C
-30V	$95m\Omega @ V_{GS} = -10V$	-2.5A
-30 V	145mΩ @ $V_{GS} = -4.5V$	-2.0A

## **Description and Applications**

This new generation MOSFET is designed to minimize the on-state resistance ( $R_{DS(ON)}$ ) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- Boost Switch
- Power Management Functions
- Analog Switch
- Load Switch

### **Features and Benefits**

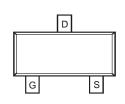
- Low On-Resistance
- Low Input Capacitance
- · Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

### **Mechanical Data**

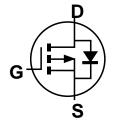
- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Terminals Connections: See Diagram Below
- Weight: 0.009 grams (Approximate)







SOT23



**Equivalent Circuit** 

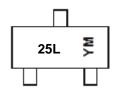
## Ordering Information (Note 4)

Part Number	Case	Packaging
DMP3125L-7	SOT23	3,000/Tape & Reel
DMP3125L-13	SOT23	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**



25L = Product Type Marking Code YM = Date Code Marking Y or Y = Year (ex: E = 2017) M = Month (ex: 9 = September)

Date Code Key

Year	2017	2018	20	019	2020	2021		20	)22	2023	202	24	2025
Code	Е	F		G	Н	- 1		,	J	K	L		М
Month	Jan	Feb	Mar	Apr	May	Jun	Jι	ıl	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	7	8	9	0	N	D



# 

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	$V_{DSS}$	-30	V	
Gate-Source Voltage	$V_{GSS}$	±20	V	
Continuous Drain Current (Note 6) $V_{GS} = -10V$ Steady $T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$		I <sub>D</sub>	-2.5 -2.0	А
Maximum Continuous Body Diode Forward Current (	Is	-1.5	Α	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	-10	Α	

## Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

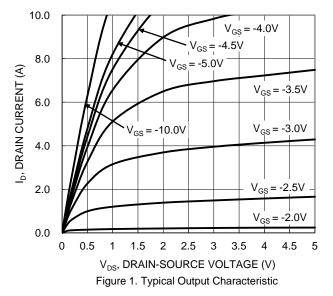
Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		$P_D$	0.65	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{ heta JA}$	191	°C/W
Total Power Dissipation (Note 6)		P <sub>D</sub>	1.2	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{ heta JA}$	103	°C/W
Operating and Storage Temperature Range		$T_{J}$ , $T_{STG}$	-55 to +150	°C

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-30	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current T <sub>J</sub> = +25°C	I <sub>DSS</sub>			-1	μA	V <sub>DS</sub> = -30V, V <sub>GS</sub> = 0V
Gate-Source Leakage	I <sub>GSS</sub>	_		±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-1.0	-	-2.1	٧	$V_{DS} = V_{GS}$ , $I_D = -250\mu A$
Static Drain-Source On-Resistance	D	1	76	95	mΩ	$V_{GS} = -10V, I_D = -3.8A$
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	108	145	11177	V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -3.0A
Diode Forward Voltage	$V_{SD}$	_	-0.85	-1.2	V	$V_{GS} = 0V, I_S = -2.7A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C <sub>iss</sub>	1	254	-	pF	
Output Capacitance	Coss	1	14	1	pF	$V_{DS} = -25V, V_{GS} = 0V$ f = 1.0MHz
Reverse Transfer Capacitance	C <sub>rss</sub>	1	7	1	pF	1 - 1.51/11/2
Gate Resistance	$R_g$	1	54	1	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge	$Q_g$	_	3.1	_	nC	
Gate-Source Charge	$Q_{gs}$	_	0.8	_	nC	$V_{GS} = -4.5V, V_{DS} = -15V$ $I_{D} = -3.8A$
Gate-Drain Charge	$Q_{gd}$	_	1.4	_	nC	10 = 3.0A
Turn-On Delay Time	t <sub>D(ON)</sub>	_	3.5	_	ns	
Turn-On Rise Time	t <sub>R</sub>	_	6.3	_	ns	V <sub>DS</sub> = -15V, V <sub>GS</sub> = -10V,
Turn-Off Delay Time	t <sub>D(OFF)</sub>	1	21.8		ns	$R_G = 6.0\Omega, I_D = -1A$
Turn-Off Fall Time	t <sub>F</sub>	_	13.1	_	ns	
Reverse Recovery Time	t <sub>RR</sub>	_	9.6		ns	I <sub>F</sub> = -1.0A, di/dt = 100A/μs
Reverse Recovery Charge	$Q_{RR}$	_	2.4	_	nC	I <sub>F</sub> = -1.0A, di/dt = 100A/μs

- Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
  Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
  Short duration pulse test used to minimize self-heating effect.
  Guaranteed by design. Not subject to product testing.





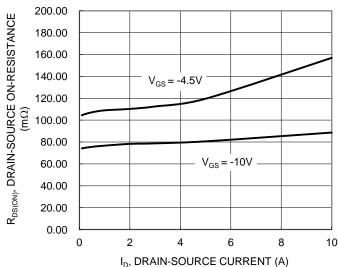
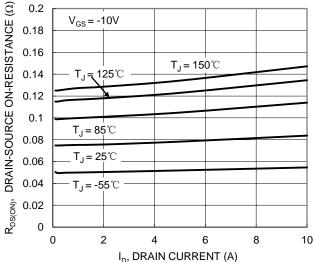


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage



I<sub>D</sub>, DRAIN CURRENT (A) Figure 5. Typical On-Resistance vs. Drain Current and Temperature

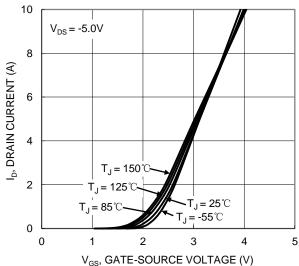
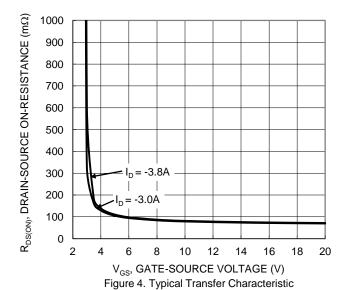


Figure 2. Typical Transfer Characteristic



2 R<sub>DS(ON)</sub>, DRAIN-SOURCE ON-RESISTANCE (NORMALIZED) 1.8 1.6  $V_{GS} = -10V, I_{D} = -3.8A$ 1.4 1.2 1  $V_{GS} = -4.5V, I_{D} = -3.0A$ 0.8 0.6 0.4 -25 0 25 50 75 100 125 150 -50

 $\mathsf{T_J},\mathsf{JUNCTION}$  TEMPERATURE (°C) Figure 6. On-Resistance Variation with Temperature



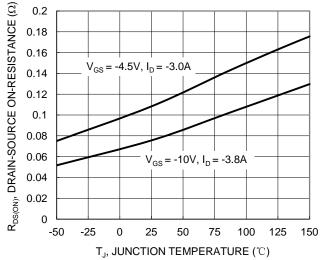
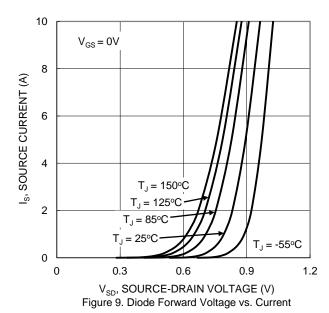
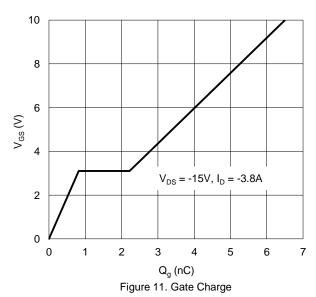


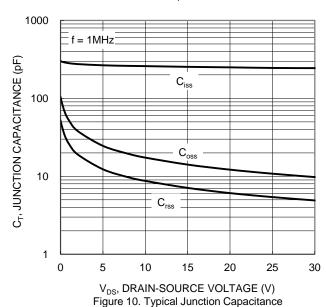
Figure 7. On-Resistance Variation with Temperature





2  $V_{GS(TH)}, \ GATE\ THRESHOLD\ VOLTAGE\ (V)$  $I_D = -1mA$ 1.5  $I_{D} = -250 \mu A$ 1 0.5 -50 -25 25 50 75 100 125 150  $T_J$ , JUNCTION TEMPERATURE (°C)

Figure 8. Gate Threshold Variation vs. Junction Temperature



100  $R_{DS(ON)}$  Limited ID, DRAIN CURRENT (A) 10 THIII 0.1  $T_{J(Max)} = 150^{\circ}C T_C = 25^{\circ}C$ Single Pulse 10s DUT on 1\*MRP Board  $V_{GS} = -10V$ 0.01 0.1 10 100 V<sub>DS</sub>, DRAIN-SOURCE VOLTAGE (V)

Figure 12. SOA, Safe Operation Area



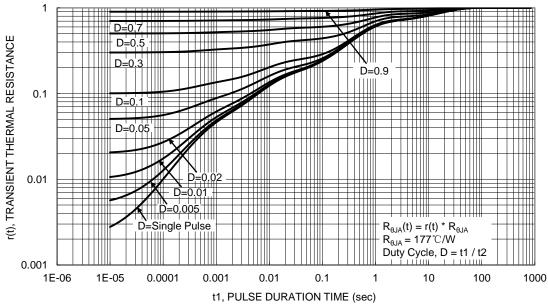


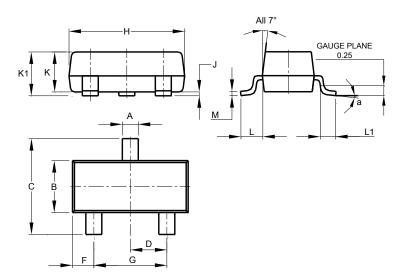
Figure 13. Transient Thermal Resistance



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### SOT23

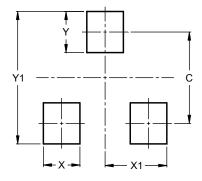


SOT23							
Dim	Min	Max	Тур				
Α	0.37	0.51	0.40				
В	1.20	1.40	1.30				
C	2.30	2.50	2.40				
D	0.89	1.03	0.915				
F	0.45	0.60	0.535				
G	1.78	2.05	1.83				
Н	2.80	3.00	2.90				
J	0.013	0.10	0.05				
K	0.890	1.00	0.975				
K1	0.903	1.10	1.025				
L	0.45	0.61	0.55				
L1	0.25	0.55	0.40				
М	0.085	0.150	0.110				
а	0°	8°					
All Dimensions in mm							

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### SOT23



Dimensions	Value (in mm)
C	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2.9

November 2017

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